

PCN – Process Change Notification

Change:	Taoglas Pin type patches
Date:	2017/11/08
Author	Haley Tsai

Affected Products

Model#	Part Number	Changes
Taoglas Pin type patches	-	1. In order to get the standard setting, we unify solder mask size on Taoglas patches.
ADFGP		2. Add affected model series list.
ADFP		
AGGBP		
AGGP		
AGPC		
AGPSF		
AP		
CGGBP		
CGGBPD		
CGGP		
CGGPD		
CGIP		
CGIPD		
DCP		
DCPD		
DCPP		
GGBTP		
GP		
GPD		
GPDF		
GPDFD		
GPH		
GPSF		
GPSFD		
GTP		
IP		
IPD		
ISMP		
ISPC		
SGP		
SGPD		

SP SPD SXP SXPDP WDP WDPD WLP WLDP WPC WTSP		
--	--	--

Type of Change

- Hardware Modification
- Production Process Advance
- Others –Unify solder mask size.

Description of Change

In order to get the standard setting, we unified solder mask size on Taoglas patches. Every piece patch ink printing will follow this standard to produce. We demonstrate the solder mask for difference sizes of patches.

Schedule

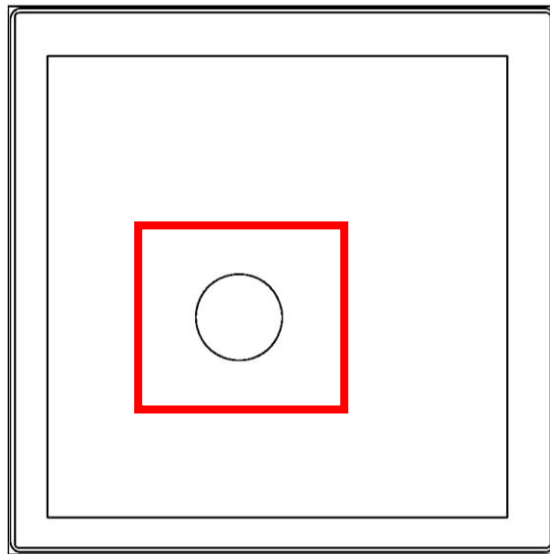
2017, November, Taoglas will provide new drawings into production.

Forecast Estimated Transition Date

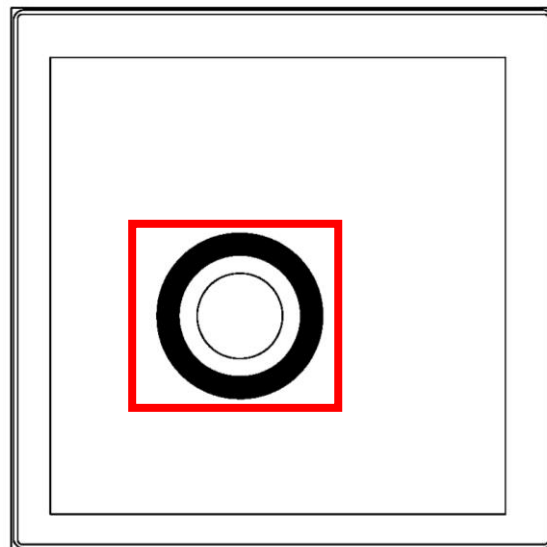
November/2017

Illustration of Change

Old drawing



New drawing



Soldermask area 